# MA4P504-1072T



**MELF PIN Diode** 1 - 4000 MHz

M/A-COM Products Rev. V1

#### **Features**

- High Power Handling
- Low Loss / Low Distortion
- Low Thermal Resistance
- Leadless Low Inductance MELF Package
- Available as a Chip
- Surface Mountable
- **RoHs Compliant**
- MSL 1

# Description

M/A-Com's MELF packaged PIN diode line encompasses a comprehensive range of electrical characteristics. The particular die in the MA4P504-1072T utilizes M/A-Com's unique CERMACHIP passivation process which provides for a hard glass encapsulation that hermetically seals the active area of the chip. This packaged CERMACHIP PIN diode is ideally suited for use in high power applications where high RF voltages are present.

The chip is enclosed in a rugged ceramic Metal Electrode Leadless Faced (MELF) surface mount package and is full face bonded to refractory metal pins on both the anode and cathode. The result is a low loss PIN diode with low thermal resistance due to symmetrical thermal paths. This rectangular PIN diode is designed for high volume tape and reel assembly. This user friendly package design provides for extremely easy automatic pick and place, indexing and assembly. All solderable surfaces are tin plated and compatible with industry standard reflow and vapor phase soldering processes.

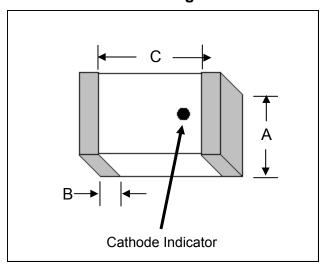
## **Applications**

The MA4P504-1072T MELF packaged PIN diode is suitable for usage in high incident power series, shunt, or series-shunt switches as well as attenuator applications from HF through UHF frequencies.

# **Ordering Information**

Part Number	Package	
Ma4P504-1072T	Tape and Reel	

# Package Style (ODS 1072) Outline **Drawing**



Dimensions	Package Style 1072		
	in	mm	
А	0.093	2.36	
В	0.050	1.27	
С	0.060	1.52	

# Absolute Maximum Ratings<sup>1,2</sup> @ 25°C

Parameter	Absolute Maximum		
Forward Voltage	1.0 V		
Reverse Voltage	500V		
Operating Temperature	-65°C to +175°C		
Storage Temperature	-65°C to +200°C		
Mounting Temperature	+260°C for 30 seconds		

- 1. Exceeding these limits may cause permanent damage to the
- 2. Values will derate over temperature.

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- Europe Tel: 44.1908.574.200 / Fax: 44.1908.574.300
- Asia/Pacific Tel: 81.44.844.8296 / Fax: 81.44.844.8298 Visit www.macom.com for additional data sheets and product information.

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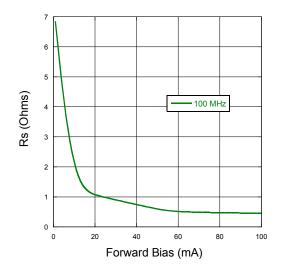
# Electrical Specifications @ T<sub>A</sub> = +25°C

Parameters	Symbols	Conditions	Units	Min.	Тур.	Max.
Total Capacitance	C <sub>T100V</sub>	-100 V @ 1 MHz	pF	_	_	0.50
Package Capacitance <sup>1</sup>	$C_p$	_	pF		0.16	
Series Resistance	R <sub>s</sub>	+100 mA @ 100 MHz	Ω	_	_	0.60
Minority Carrier Lifetime	T <sub>L</sub>	$I_F = 10 \text{ mA}$ $I_R = -6 \text{ mA}$	μS	_	1.0	_
Forward Voltage	$V_{F}$	+ 50 mA	V	_	_	1.0
Reverse Leakage Current	-I <sub>R</sub>	-500 V	μΑ	_	_	- 10
Thermal Resistance	θ	_	°C / W	_	15	_
Power Dissipation	Pd	_	W	_	_	10
3rd Order Input Intermodulation Distor- tion	IIP3	+10dBm Input Power 1000 MHz 1 MHz Spacing	dBm	_	>54	_

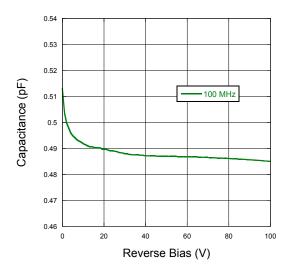
<sup>1.</sup> Package capacitance is for the MELF-1072 package style. Total capacitance Ct = Junction Capacitance Cj + Package Capacitance Cp

# **Typical DC Performance Curves**

#### Series Resistance vs. Forward Current



### Capacitance vs. Reverse Voltage



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MELF PIN Diode 1 - 4000 MHz

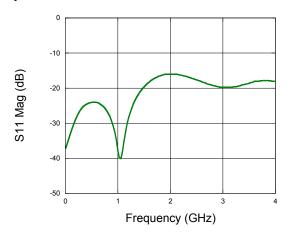
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# **APPLICATIONS SECTION**

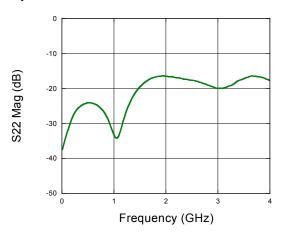
# Typical RF Performance Curves (50 - 4000 MHz)

### **SERIES DIODE**

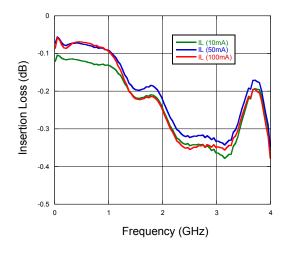
# Input Return Loss



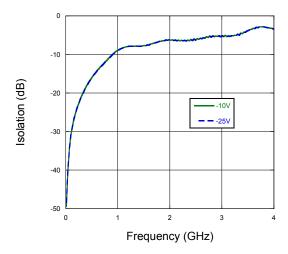
# **Output Return Loss**



### **Insertion Loss**



### Isolation



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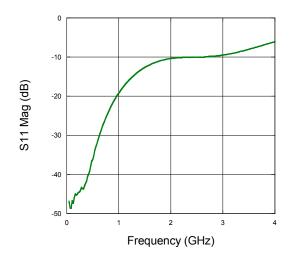
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# **APPLICATIONS SECTION**

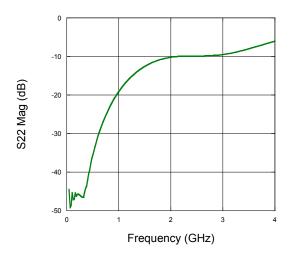
# Typical RF Performance Curves (50 – 4000 MHz)

#### **SHUNT DIODE**

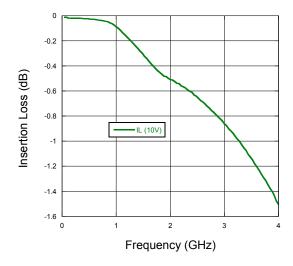
# Input Return Loss



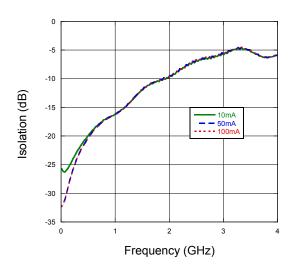
### **Output Return Loss**



# Insertion Loss



# Isolation



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# **Assembly Recommendations**

- Devices may be soldered using standard 63/37, Sn/Pb or RoHS compliant solders. Leads are tin plated 50µM thick to ensure an optimum connection.
- For recommended Sn/Pb and RoHS soldering profile See Application Note <u>M538</u> on the M/A-COM website.

# **Handling Procedures**

The following precautions should be observed to avoid damaging these devices.

# **Cleanliness and Storage**

These devices should be handled and stored in a clean environment. Ends of the device are tin plated for greater solderability. Continuous exposure to high humidity (>80%) for extended periods may cause the surface to oxidize. Caution should be taken when storing devices for long periods.

### **ESD**

These devices are susceptible to ESD and are rated Class 1C.

### **General Handling**

Device can be handled with tweezers or vacuum pickups and are suitable for use with automatic pick-and-place equipment.

**Note**: To compare other MELF packaged diodes to the MA4P504-1072, please click on the link to an older version datasheet:

PACKAGED PIN DIODES

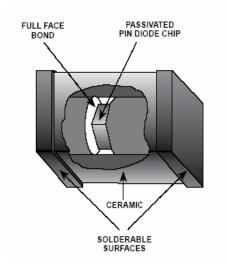
### **RoHS**

The MA4P504-1072 is fully RoHS compliant meaning it contains less than the maximum allowable concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium.

# **Mounting Techniques**

#### **Solder Attach**

Typical wave soldering or reflow techniques may be used to mount M/A-COM's SMQ packages to circuit boards using Sn63/Pb37 alloy or RoHS compliant solders. For more information visit the M/A-COM website and read application note M538.



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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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